

US00D505426S

(12) **United States Design Patent**
Lin

(10) **Patent No.:** **US D505,426 S**

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(54) **COMPUTER MAINFRAME FRONT PANEL**

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Taipei Hsien (TW)

(**) **Term:** **14 Years**

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(51) **LOC (7) Cl.** **14-02**

(52) **U.S. Cl.** **D14/441**

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D14/432; D13/162, 184, 199; 312/223.2;
360/99.01-99.12; 361/680-686, 690-696;
369/34.01, 36.01

(56) **References Cited**

U.S. PATENT DOCUMENTS

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(57) **CLAIM**

The ornamental design for a computer mainframe front panel, as shown and described.

DESCRIPTION

FIG. 1 is a top, front and right side perspective view of a computer mainframe front panel showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof. FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; FIG. 8 is a top, front and left side perspective view thereof, shown with the fronts in an open position; and, FIG. 9 is a top, front and right side perspective view thereof, shown with the fronts in an open position.

1 Claim, 7 Drawing Sheets

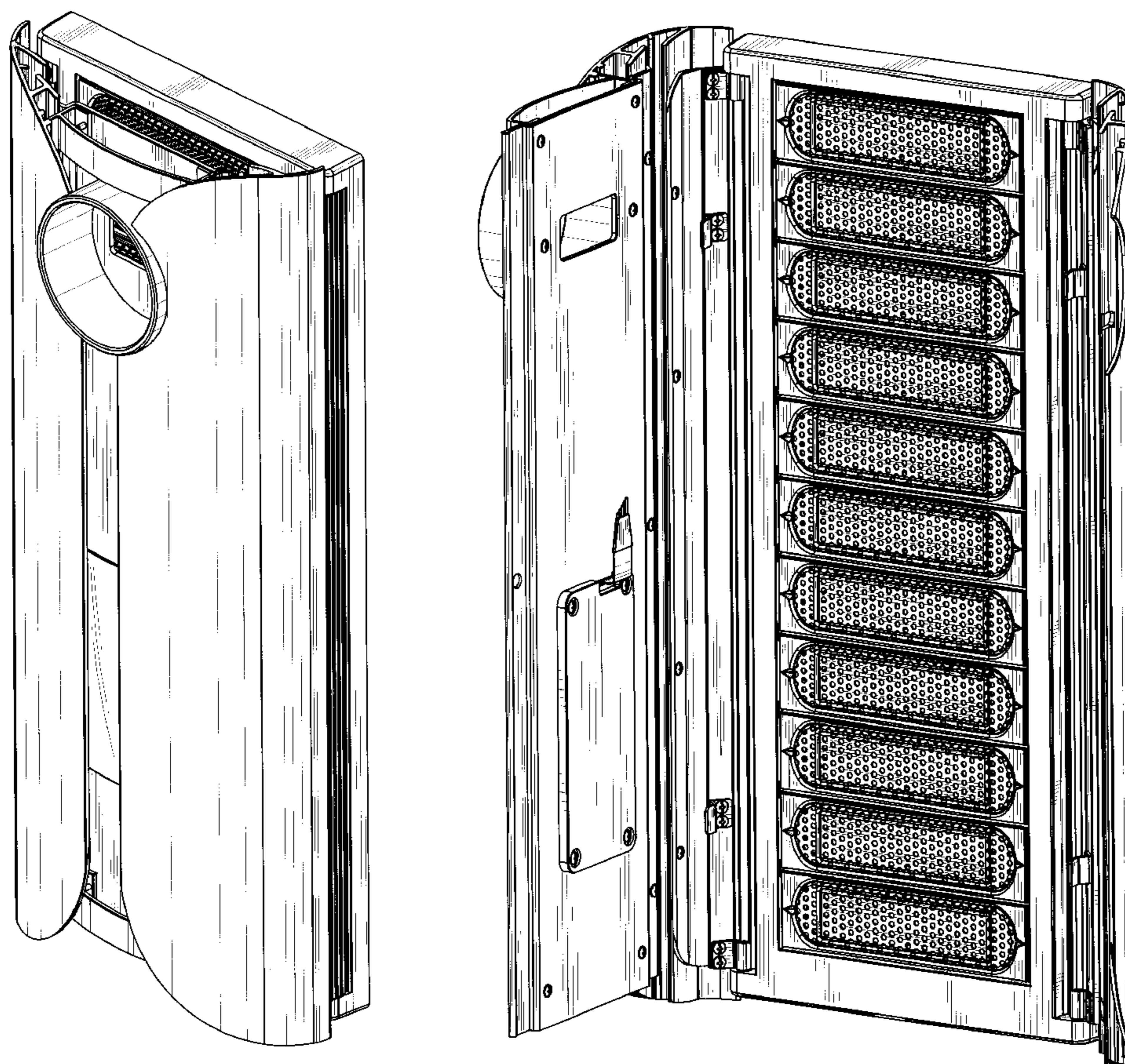




Fig. 1

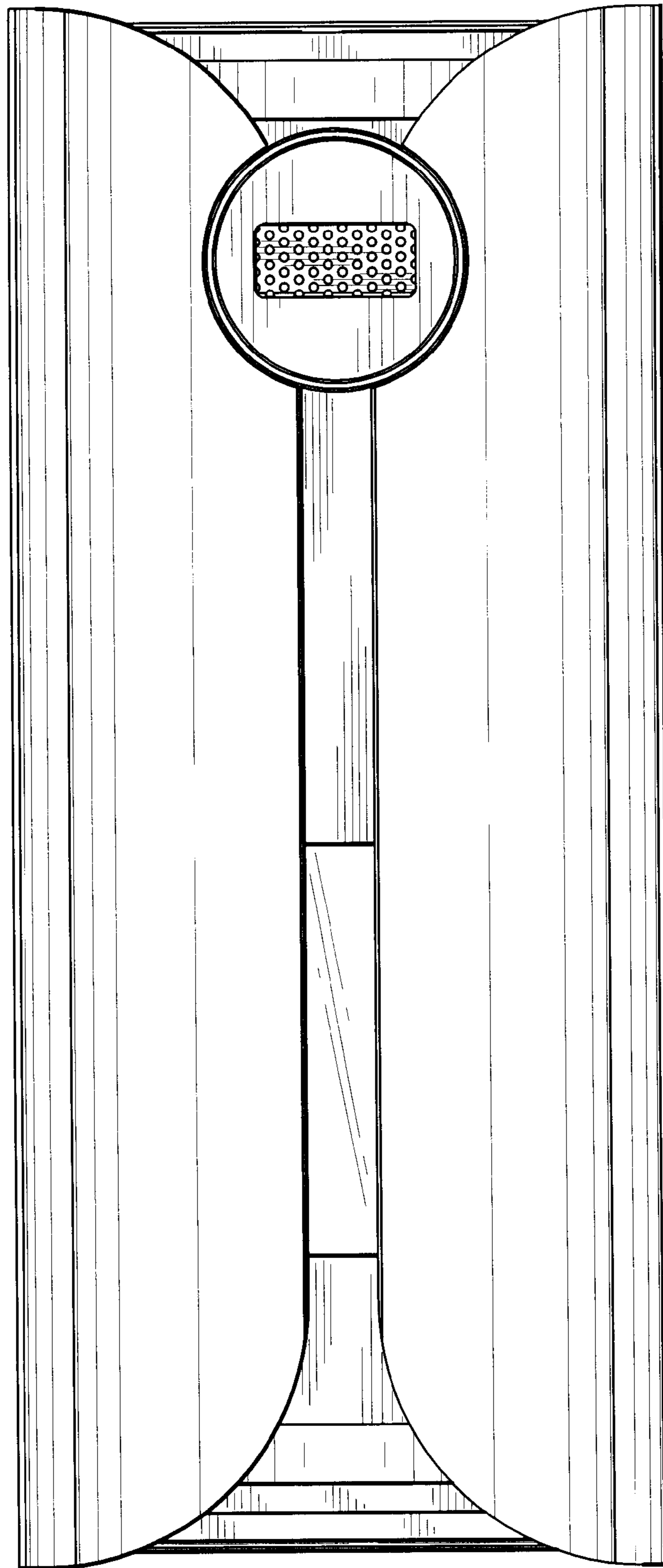


Fig. 2

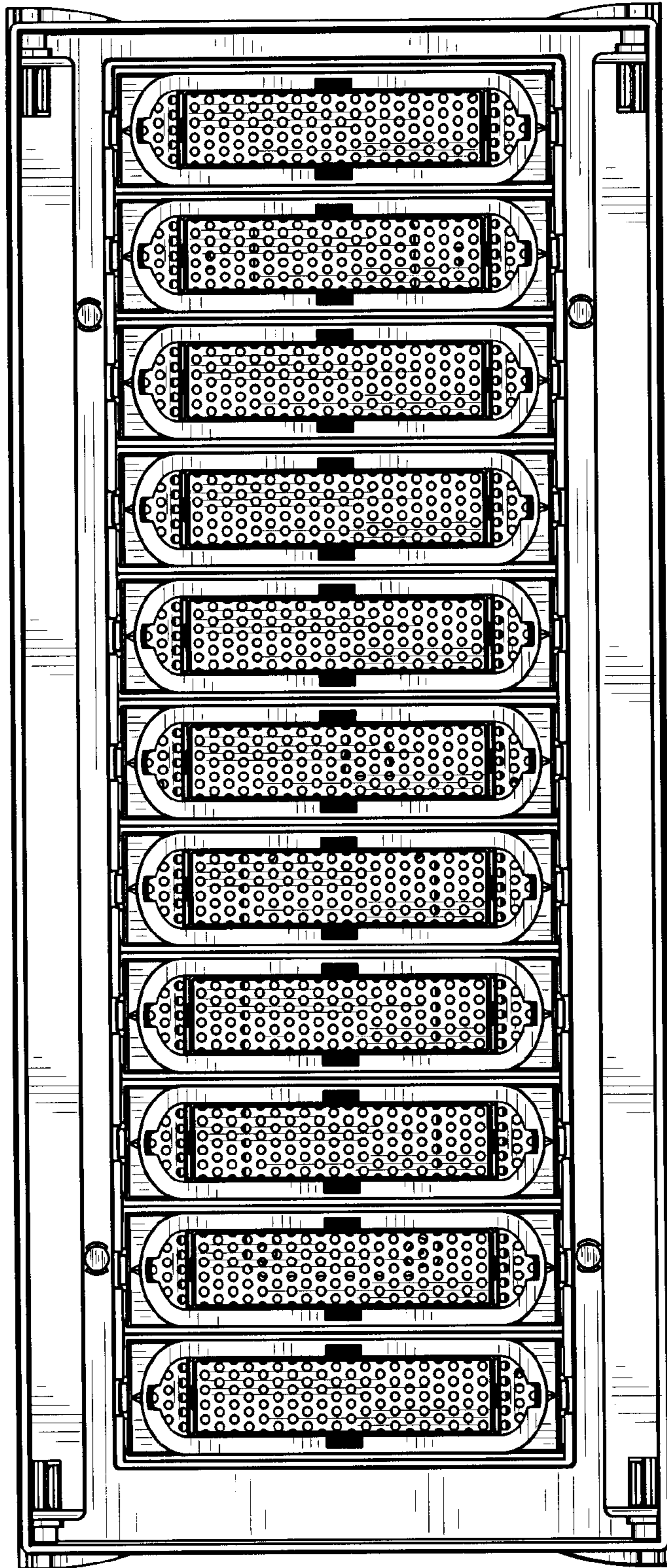


Fig. 3

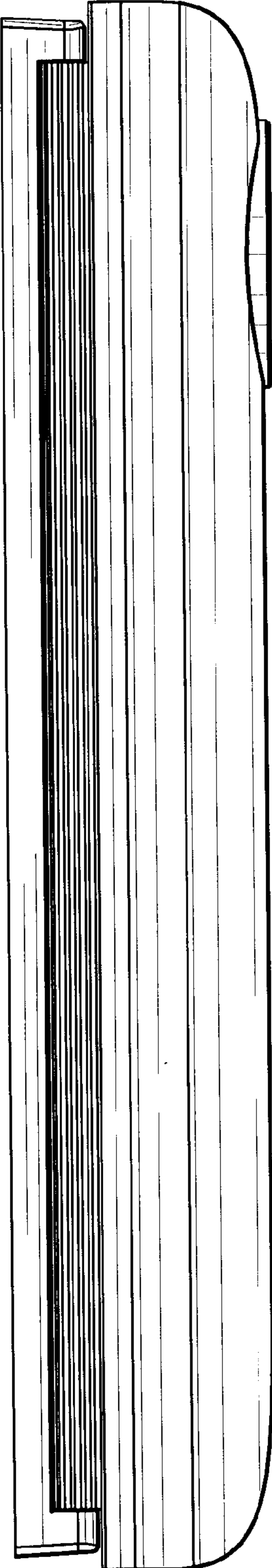


Fig. 4

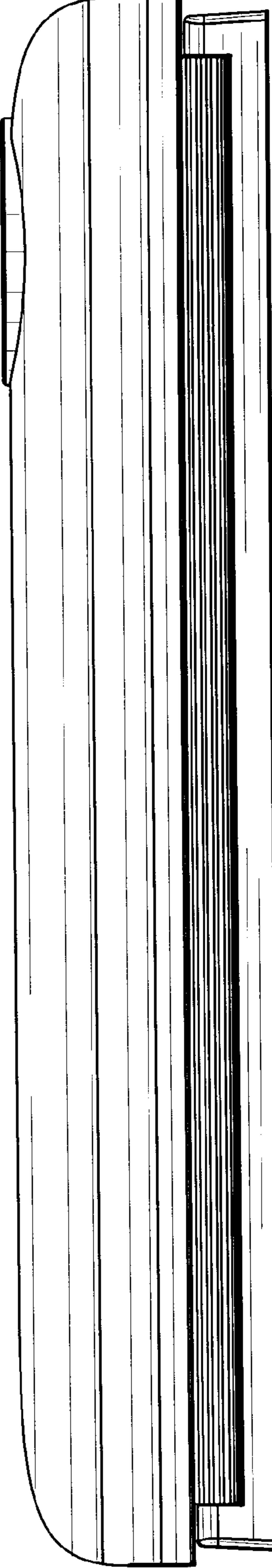


Fig. 5

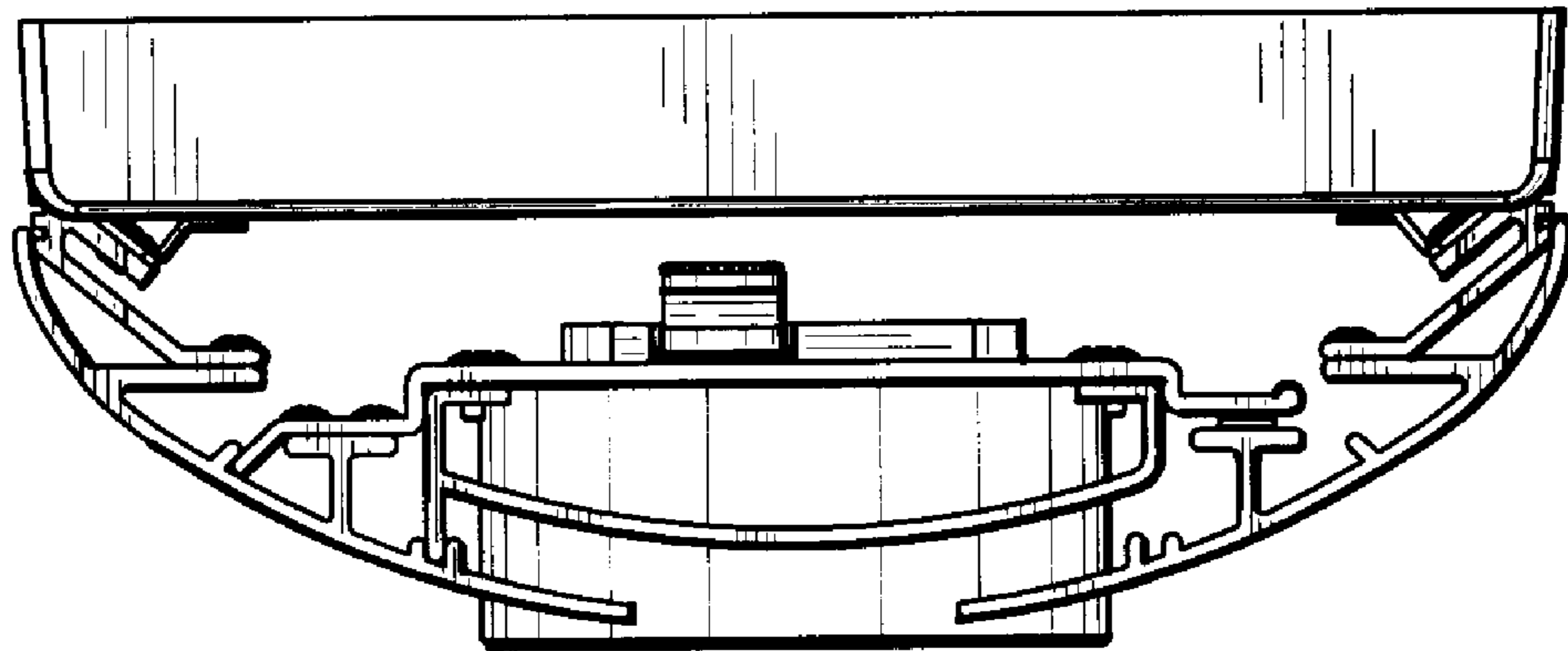


Fig. 6

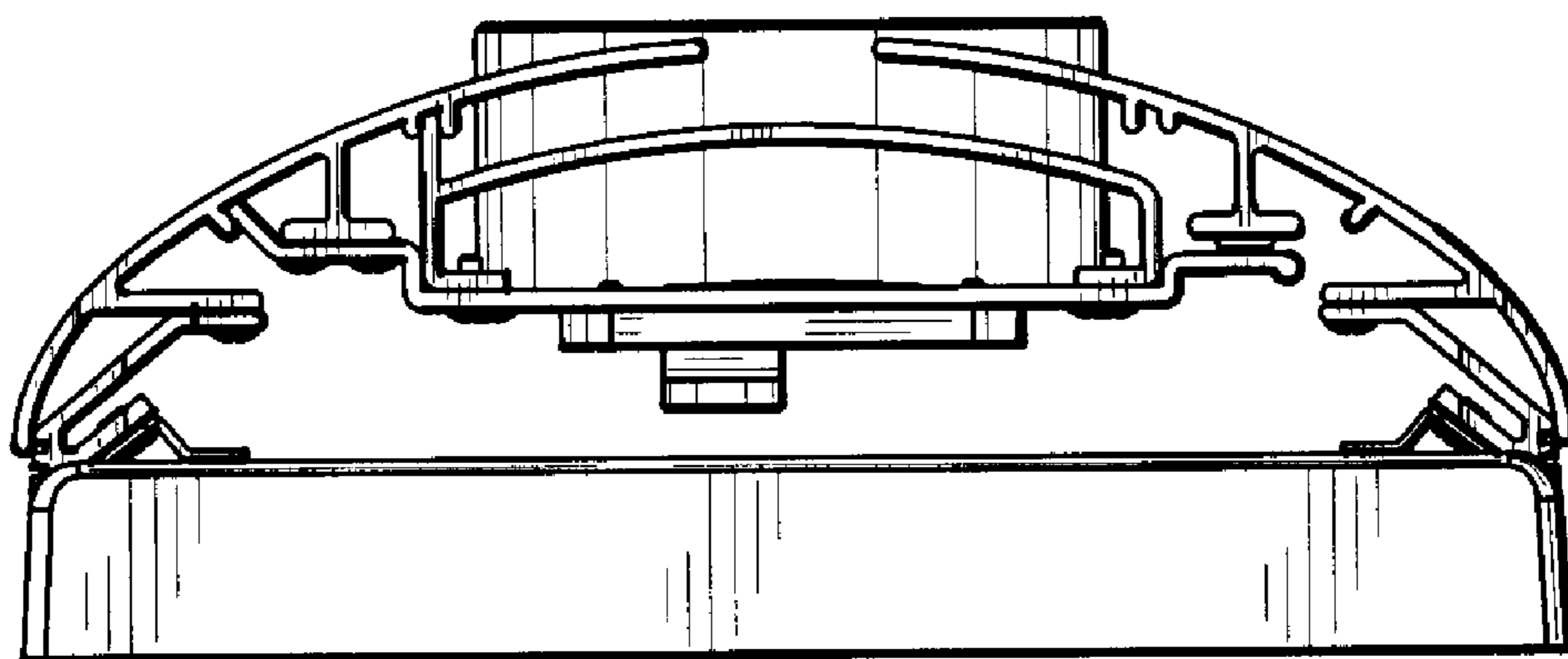


Fig. 7

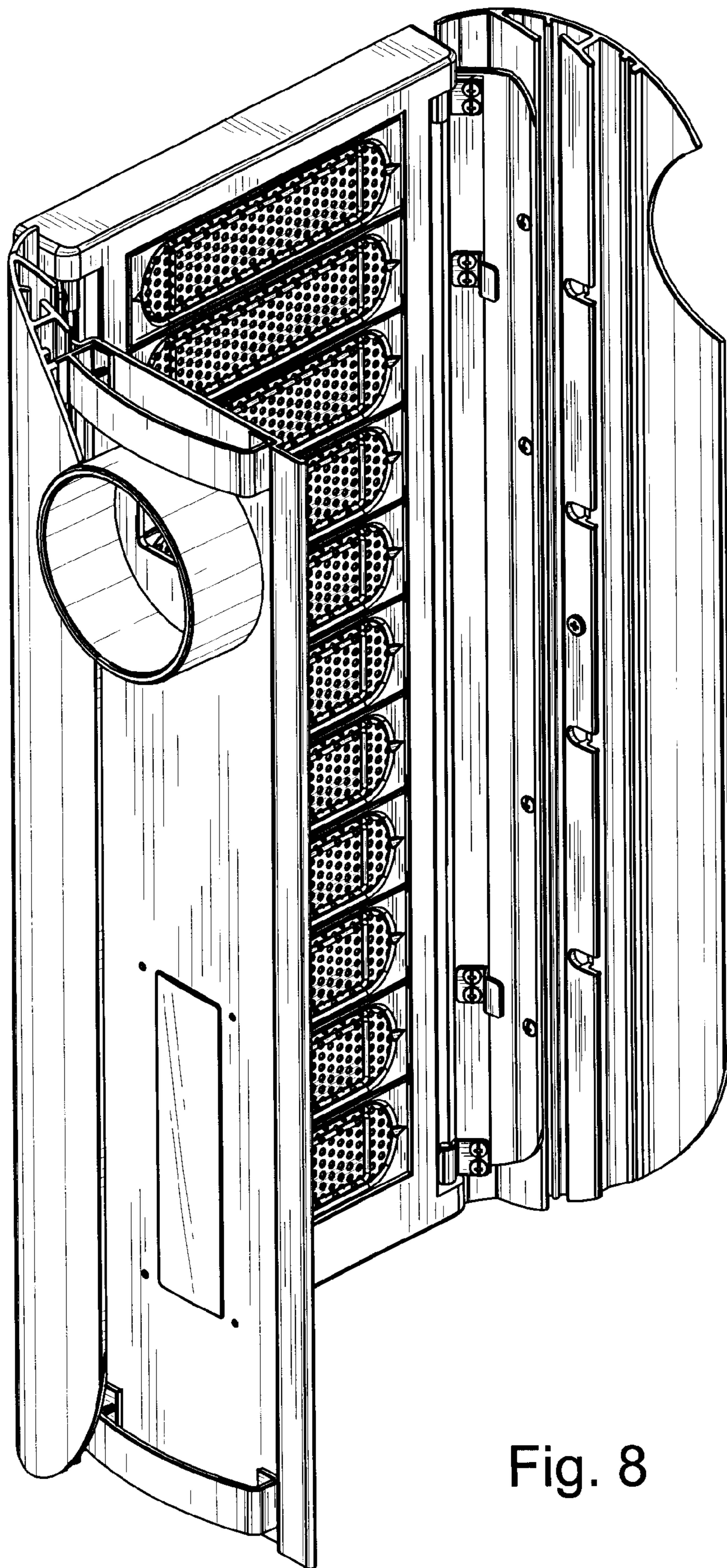


Fig. 8

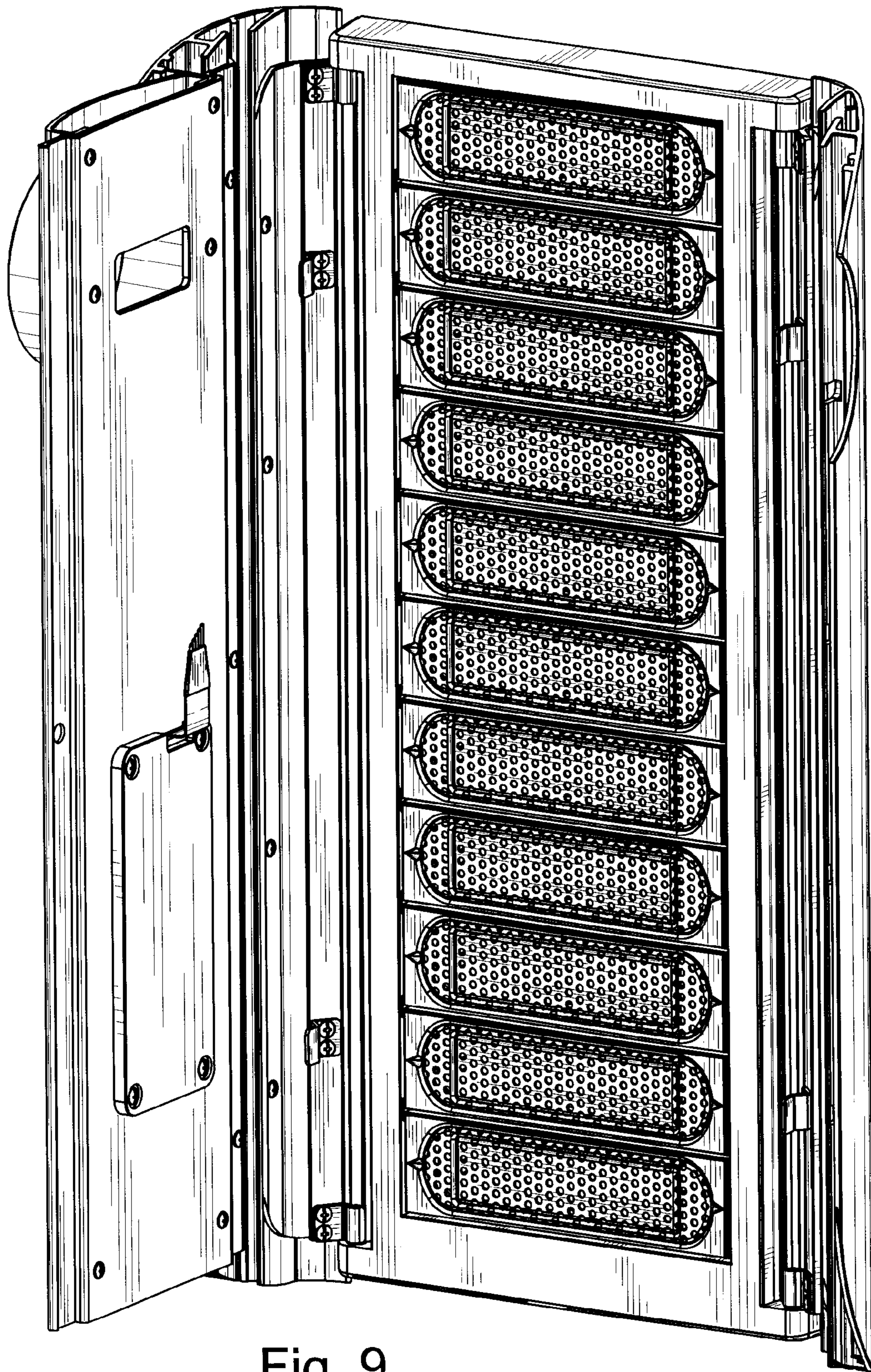


Fig. 9